STF202-22T1 Series

Advance Information

EMI Filter with ESD Protection

Features:

- Provides USB Line Termination, Filtering and ESD Protection
- Single IC Offers Cost Savings by Replacing 3 Resistors, 2 Capacitors, and 5 TVs diodes
- Bi-directional EMI Filtering Prevents Noise from Entering/Leaving the System
- IEC61000-4-2 ESD Protection for USB Port
- Flexible Pull-down or Pull-up Line Termination to Meet USB 1.1 Low Speed and High Speed Specification

Benefits:

- TSOP-6 Package Minimizes PCB Space
- Integrated Circuit Increases System Reliability versus Discrete Component Implementation
- TVs Devices Provide ESD Protection That is Better than a Discrete Implementation because the Small IC minimizes Parasitic Inductances

Typical Applications:

- USB Serial Ports
- Portable Equipment
- Cellular Phones
- Computers

MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Rating	Symbol	Value	Unit
Steady State Power	P_{D}	225	mW
IEC61000–4–2 (Level 4) Air Discharge Contact Discharge	V_{PP}	16 8.0	kV
Maximum Junction Temperature	T_J	150	°C
Lead Solder Temperature (10 second duration)	T _L	260	°C

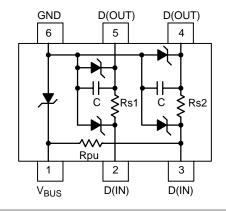
This document contains information on a new product. Specifications and information herein are subject to change without notice.



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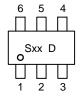
CIRCUIT DESCRIPTION





TSOP-6 CASE 318G STYLE 8

MARKING DIAGRAM



Sxx = Specific Device Code

xx = 22 or 30 D = Date Code

ORDERING INFORMATION

Device	Package	Shipping			
STF202-22T1	TSOP-6	3000/Tape & Reel			
STF202-30T1	TSOP-6	3000/Tape & Reel			

STF202-22T1 Series

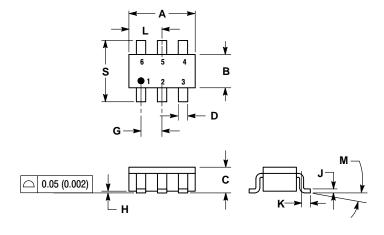
ELECTRICAL CHARACTERISTICS

			V _{BR} @1 mA		Max I _R @ V _{RWM} = 5.25 V	Max I _R @ V _{RWM} = 3.3 V	Typical Total Line Capacitance	Series Resistor Rs (Ω)			-up Res Rup (kΩ		
Device	Device Marking	V _{RWM} (Volts)	Min	Max	V _{BUS} to GND (μA)	= 3.3 V I/O Pin (μA)	I/O Pins to GND (pF)	Min	Nom	Max	Min	Nom	Max
STF202-22T1	S22	5.25	6.0	8.0	5.0	1.0	60	20	22	24	1.35	1.5	1.65
STF202-30T1	S30	5.25	6.0	8.0	5.0	1.0	60	27	30	33	1.35	1.5	1.65

OUTLINE DIMENSIONS

EMI Filter with ESD Protection

TSOP-6 CASE 318G-02 ISSUE H



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	2.90	3.10	0.1142	0.1220	
В	1.30	1.70	0.0512	0.0669	
С	0.90	1.10	0.0354	0.0433	
D	0.25	0.50	0.0098	0.0197	
G	0.85	1.05	0.0335	0.0413	
Н	0.013	0.100	0.0005	0.0040	
J	0.10	0.26	0.0040	0.0102	
K	0.20	0.60	0.0079	0.0236	
L	1.25	1.55	0.0493	0.0610	
M	0 °	10°	0 °	10°	
S	2.50	3.00	0.0985	0.1181	

STYLE 1: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SOURCE 5. DRAIN 6. DRAIN	STYLE 2: PIN 1. EMITTER 2 2. BASE 1 3. COLLECTOR 1 4. EMITTER 1 5. BASE 2 6. COLLECTOR 2	STYLE 3: PIN 1. ENABLE 2. N/C 3. R BOOST 4. Vz 5. V in 6. V out	STYLE 4: PIN 1. N/C 2. V in 3. NOT USED 4. GROUND 5. ENABLE 6. LOAD
STYLE 5: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 6: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER 5. COLLECTOR 6. COLLECTOR	STYLE 7: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. N/C 5. COLLECTOR 6. EMITTER	STYLE 8: PIN 1. Vbus 2. D(in)- 3. D(in)+ 4. D(out)+ 5. D(out)- 6. GND

STF202-22T1 Series

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